

THREE DIMENSIONAL ELECTROASSEMBLY

ABSTRACT OF THE DISCLOSURE

A process for forming a three dimensional

- 5 decorative pattern on a product substrate uses
electrostatic forces placed on dielectric fibers and
electrostatic latent images written either onto an
intended product substrate or onto a transfer surface, or
both, to assemble three dimensional composite structures
10 of fibers or rod-shaped components in a matrix of a
second dielectric material. The fibers or other rod-
shaped components may extend from the matrix to form a
surface that is either plush or relatively smooth. The
transfer surface may be a photoconductor with an
15 electrostatic latent image that is written with
controlled light or it can be made of a dielectric
material and be rigid and conforming to the intended
product substrate or flexible and made to conform to the
intended product substrate.

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